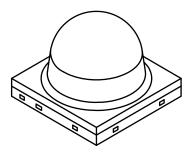
VSMY98525DS



Vishay Semiconductors

High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology



DESCRIPTION

As part of the <u>SurfLightTM</u> portfolio, the VSMY98525DS is an infrared, 850 nm emitting diode based on surface emitter technology with high radiant power and high speed, molded in low thermal resistance SMD package with lens. A 42 mil chip provides outstanding radiant intensity and allows DC operation of the device up to 1 A. Superior ESD characteristics are ensured by an integrated Zener diode.

FEATURES

- Package type: surface-mount
- Double stack technology
- Package form: power QFN
- Dimensions (L x W x H in mm): 3.85 x 3.85 x 3.00
- Peak wavelength: $\lambda_p = 850 \text{ nm}$
- Zener diode for ESD protection up to 2 kV
- High radiant power
- High radiant intensity
- Angle of half intensity: $\phi = \pm 25^{\circ}$
- Designed for high drive currents: up to 1 A (DC) and up to 5 A pulses
- Low thermal resistance: R_{thJP} = 9 K/W
- Floor life: 168 h, MSL 3, according to J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Infrared illumination for CMOS cameras (CCTV)
- Illumination for cameras (3D gaming)
- Machine vision

PRODUCT SUMMARY					
COMPONENT	l _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)	
VSMY98525DS	1000	± 25	850	14	

Note

Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY98525DS	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens	

Note

• MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	1	A	
Peak forward current	$t_p/T = 0.5, t_p = 100 \ \mu s$	I _{FM}	2	A	
Surge forward current	t _p = 100 μs	I _{FSM}	5	A	
Power dissipation		Pv	3.5	W	
Junction temperature		Tj	115	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-55 to +100	°C	
Soldering temperature	According to Fig. 7, J-STD-20	T _{sd}	260	°C	
Thermal resistance junction-to-pin	JESD 51	R _{thJP}	9	K/W	

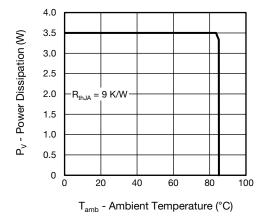
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1 For technical questions, contact: <u>emittertechsupport@vishay.com</u> Document Number: 84908

Pb-free

FREE <u>GREEN</u> (5-2008)





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Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

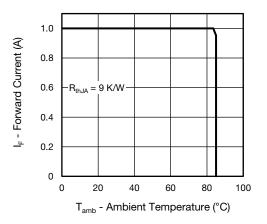


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_{\rm F} = 1 \text{ A}, t_{\rm p} = 20 \text{ ms}$	V _F	-	3.1	3.5	V
Temperature coefficient of V_F	I _F = 1 A		-	-3	-	mV/K
Reverse current	V _R = 5 V	I _R	-	-	10	μA
Junction capacitance	$V_{R} = 0 V, f = 1 MHz, E = 0 mW/cm^{2}$	CJ	-	130	-	pF
Radiant intensity	I _F = 1 A, t _p = 20 ms	l _e	800	1000	1600	mW/sr
Radiant power	$I_{\rm F} = 1 \text{ A}, t_{\rm p} = 20 \text{ ms}$	фе	-	1300	-	mW
Temperature coefficient of $\boldsymbol{\phi}$	$I_{\rm F} = 1 \text{ A}, t_{\rm p} = 20 \text{ ms}$	ΤK _φ	-	-0.3	-	%/K
Angle of half intensity		φ	-	± 25	-	deg
Peak wavelength	I _F = 1 A	λ _p	830	850	870	nm
Spectral bandwidth	I _F = 1 A	Δλ	-	35	-	nm
Temperature coefficient of λ_p	I _F = 1 A, t _p = 20 ms	$TK_{\lambda p}$	-	0.3	-	nm/K
Rise time	I _F = 1 A	t _r	-	14	-	ns
Fall time	I _F = 1 A	t _f	-	17	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

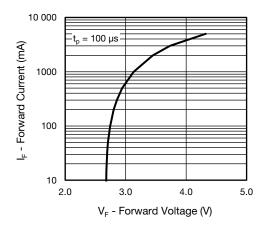


Fig. 3 - Forward Current vs. Forward Voltage

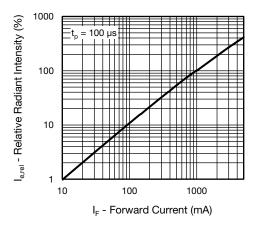


Fig. 4 - Relative Radiant Intensity vs. Forward Current

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20°

30°

40°

50°

60°

70°

80°

φ - Angular Displacement

10°

0°

l_{e, rel} - Relative Radiant Intensity

1.0

0.9

0.8

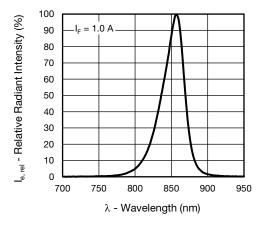
0.7

0.6

0.4

0.2 0

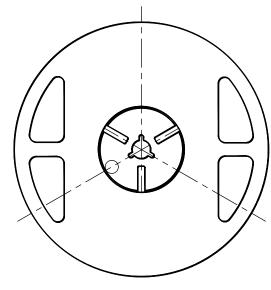
Fig. 6 - Relative Radiant Intensity vs. Angular Displacement

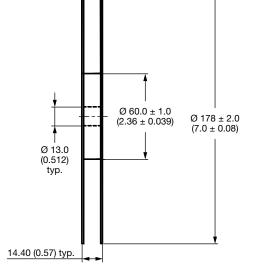


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Fig. 5 - Relative Radiant Intensity vs. Wavelength

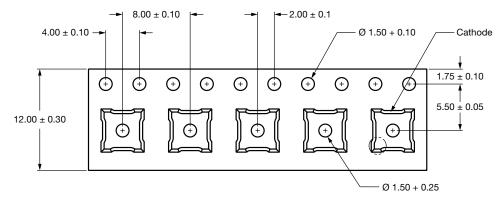
TAPING DIMENSIONS in millimeters





Notes

- · Empty component pockets sealed with top cover tape
- 7 inch reel 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI/EIA 481-1-A-1994 specifications



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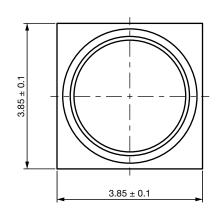
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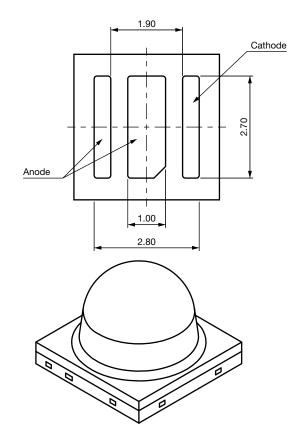
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PACKAGE DIMENSIONS in millimeters





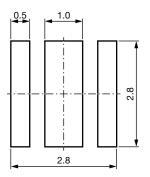
Notes

 0.40 ± 0.05 0.30 ± 0.05

P0.20

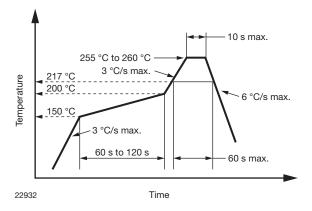
• Tolerance is ± 0.10 mm (0.004") unless otherwise noted

• Specifications are subject to change without notice



3.00

SOLDER PROFILE



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Fig. 7 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: $T_{amb} < 30\ ^\circ C,\ RH < 60\ \%$

Moisture sensitivity level 3, according to J-STD-020B

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



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